

MC74AC175, MC74ACT175

Quad D Flip-Flop With Master Reset

The MC74AC/ACT175 is a high-speed quad D flip-flop. The device is useful for general flip-flop requirements where clock and clear inputs are common. The information on the D inputs is transferred to storage during the LOW-to-HIGH clock transition. The device has a Master Reset to simultaneously clear all flip-flops, when MR is low.

The MC74AC/ACT175 consists of four edge-triggered D flip-flops with individual D inputs and Q and Q outputs. The Clock (CP) and Master Reset (MR) are common to all flip-flops. Each D input's state is transferred to the corresponding flip-flop's output following the LOW-to-HIGH Clock (CP) transition. A LOW input to the Master Reset (MR) will force all Q outputs LOW and Q outputs HIGH independent of Clock or Data inputs. The MC74AC/ACT175 is useful for applications where the Clock and Master Reset are common to all storage elements.

- Outputs Source/Sink 24 mA
- 'ACT175 Has TTL Compatible Inputs

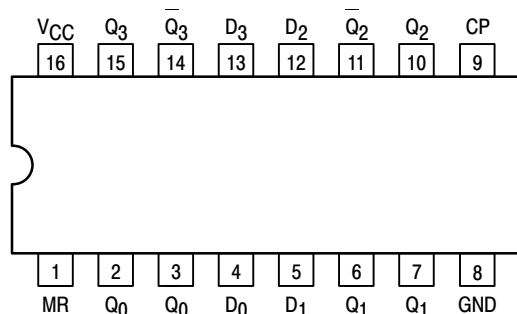


Figure 1. Pinout: 16-Lead Packages
(Top View)

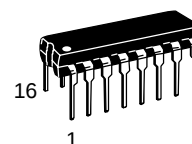
PIN ASSIGNMENT

PIN	FUNCTION
D ₀ – D ₃	Data Inputs
CP	Clock Pulse Input
MR	Master Reset Input
Q ₀ – Q ₃	Outputs
Q ₀ – Q ₃	Outputs

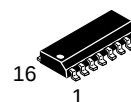


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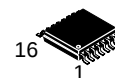
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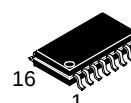
DIP-16
N SUFFIX
CASE 648



SO-16
D SUFFIX
CASE 751B



TSSOP-16
DT SUFFIX
CASE 948F



EIAJ-16
M SUFFIX
CASE 966

ORDERING INFORMATION

Device	Package	Shipping
MC74AC175N	PDIP-16	25 Units/Rail
MC74ACT175N	PDIP-16	25 Units/Rail
MC74AC175D	SOIC-16	48 Units/Rail
MC74ACT175D	SOIC-16	48 Units/Rail
MC74AC175DR2	SOIC-16	2500 Tape & Reel
MC74ACT175DR2	SOIC-16	2500 Tape & Reel
MC74AC175DT	TSSOP-16	96 Units/Rail
MC74ACT175DT	TSSOP-16	96 Units/Rail
MC74AC175DTR2	TSSOP-16	2500 Tape & Reel
MC74ACT175DTR2	TSSOP-16	2500 Tape & Reel
MC74AC175M	EIAJ-16	50 Units/Rail

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 6 of this data sheet.

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TRUTH TABLE

Inputs			Outputs	
MR	CP	D	Q _n	Q _n
L	X	X	L	H
H	┐	H	H	L
H	┐	L	L	H
H	L	X	Q _n	Q _n

NOTE: H = HIGH Voltage Level,
L = LOW Voltage Level
X = Immaterial
┐ = LOW-to-HIGH Transition of Clock

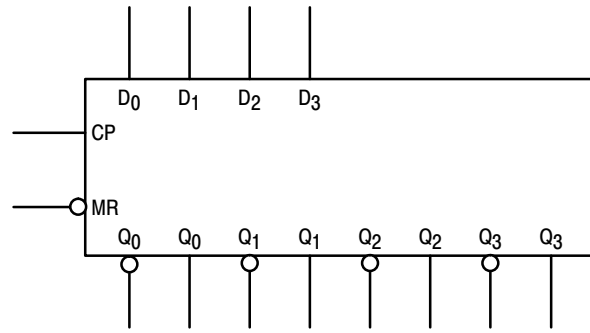
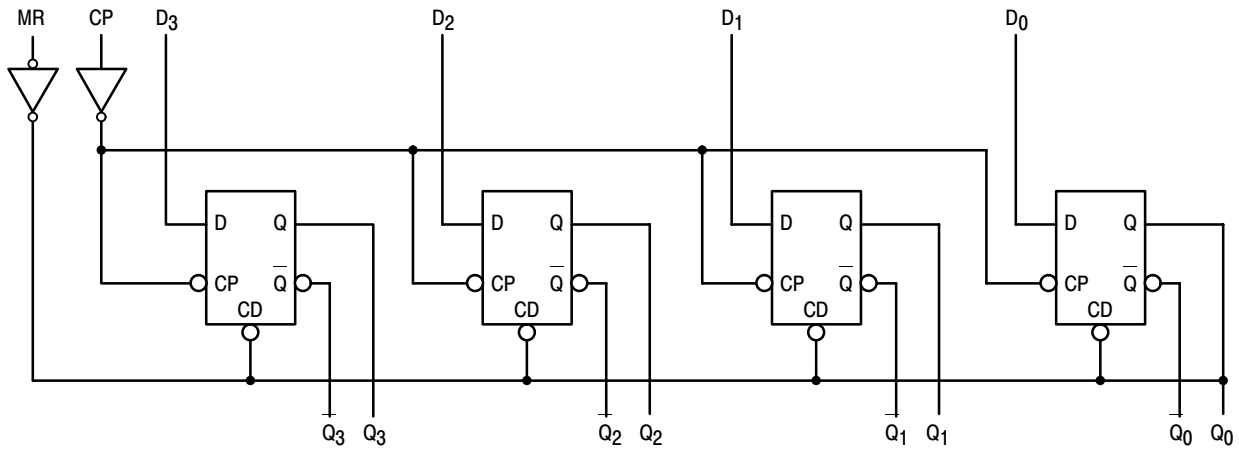


Figure 2. Logic Symbol



NOTE: This diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Figure 3. Logic Diagram

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V _{IN}	DC Input Voltage (Referenced to GND)	-0.5 to V _{CC} + 0.5	V
V _{OUT}	DC Output Voltage (Referenced to GND)	-0.5 to V _{CC} + 0.5	V
I _{IN}	DC Input Current, per Pin	± 20	mA
I _{OUT}	DC Output Sink/Source Current, per Pin	± 50	mA
I _{CC}	DC V _{CC} or GND Current per Output Pin	± 50	mA
T _{stg}	Storage Temperature	-65 to +150	°C

*Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

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RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Min	Unit
V _{CC}	Supply Voltage	'AC	2.0	5.0	6.0
		'ACT	4.5	5.0	5.5
V _{in} , V _{out}	DC Input Voltage, Output Voltage (Ref. to GND)	0	–	V _{CC}	V
t _r , t _f	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 3.0 V	–	150	–
		V _{CC} @ 4.5 V	–	40	–
		V _{CC} @ 5.5 V	–	25	–
t _r , t _f	Input Rise and Fall Time (Note 2) 'ACT Devices except Schmitt Inputs	V _{CC} @ 4.5 V	–	10	–
		V _{CC} @ 5.5 V	–	8.0	–
T _J	Junction Temperature (PDIP)	–	–	140	°C
T _A	Operating Ambient Temperature Range	–40	25	85	°C
I _{OH}	Output Current – HIGH	–	–	–24	mA
I _{OL}	Output Current – LOW	–	–	24	mA

1. V_{IN} from 30% to 70% V_{CC}; see individual Data Sheets for devices that differ from the typical input rise and fall times.
2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	74AC		74AC	Unit	Conditions
			T _A = +25°C		T _A = –40°C to +85°C		
			Typ	Guaranteed Limits			
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V	I _{OUT} = – 50 μA
		3.0 4.5 5.5	– – –	2.56 3.86 4.86	2.46 3.76 4.76	V	*V _{IN} = V _{IL} or V _{IH} – 12 mA I _{OH} – 24 mA – 24 mA
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	I _{OUT} = 50 μA
		3.0 4.5 5.5	– – –	0.36 0.36 0.36	0.44 0.44 0.44	V	*V _{IN} = V _{IL} or V _{IH} 12 mA I _{OH} 24 mA 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	–	±0.1	±1.0	μA	V _I = V _{CC} , GND
I _{OLD}	†Minimum Dynamic Output Current	5.5	–	–	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}		5.5	–	–	–75	mA	V _{OHD} = 3.85 V Min

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

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DC CHARACTERISTICS (continued)

Symbol	Parameter	V _{CC} (V)	74AC		74AC		Unit	Conditions
			T _A = +25°C		T _A = −40°C to +85°C			
			Typ	Guaranteed Limits				
I _{CC}	Maximum Quiescent Supply Current	5.5	–	8.0	80		μA	V _{IN} = V _{CC} or GND

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

AC CHARACTERISTICS

Symbol	Parameter	V _{CC} * (V)	74AC			74AC		Unit	Fig. No.
			T _A = +25°C C _L = 50 pF			T _A = −40°C to +85°C C _L = 50 pF			
			Min	Typ	Max	Min	Max		
f _{max}	Maximum Clock Frequency	3.3 5.0	149 187	— —	— —	139 187	— —	MHz	3–3
t _{PLH}	Propagation Delay CP to Q _N or Q _n	3.3 5.0	2.0 1.5	— —	12.0 9.0	2.0 1.0	13.5 9.5	ns	3–6
t _{PHL}	Propagation Delay CP to Q _N or Q _n	3.3 5.0	2.5 1.5	— —	13.0 9.5	2.0 1.5	14.5 10.5	ns	3–6
t _{PLH}	Propagation Delay MR to Q _N	3.3 5.0	3.0 2.0	— —	12.5 9.0	2.5 1.5	13.5 10.0	ns	3–6
t _{PHL}	Propagation Delay MR to Q _N	3.3 5.0	3.0 2.0	— —	11.0 8.5	2.5 1.5	12.5 9.0	ns	3–6

AC OPERATING REQUIREMENTS

Symbol	Parameter	V _{CC} * (V)	74AC		74AC	Unit	Fig. No.
			T _A = +25°C C _L = 50 pF		T _A = −40°C to +85°C C _L = 50 pF		
			Typ	Guaranteed Minimum			
t _s	Set-up Time, HIGH or LOW D _n to CP	3.3 5.0	– –	4.5 3.0	4.5 3.0	ns	3–9
t _h	Hold Time, HIGH or LOW D _n to CP	3.3 5.0	– –	1.0 1.0	1.0 1.0	ns	3–9
t _w	MR Pulse Width Low	3.3 5.0	– –	4.5 3.5	4.5 3.5	ns	3–6
t _w	CP Pulse Width	3.3 5.0	– –	4.5 3.5	5.0 3.5	ns	3–6
t _{rec}	Recovery Time MR to CP	3.3 5.0	– –	0 0	0 0	ns	3–6

*Voltage Range 3.3 V is 3.3 V ±0.3 V.

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

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DC CHARACTERISTICS

Symbol	Parameter	V _{CC} (V)	74ACT		74ACT	Unit	Conditions
			T _A = +25°C		T _A = –40°C to +85°C		
			Typ	Guaranteed Limits			
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	V _{OUT} = 0.1 V or V _{CC} – 0.1 V
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	I _{OUT} = – 50 μA
		4.5 5.5	– –	3.86 4.86	3.76 4.76	V	*V _{IN} = V _{IL} or V _{IH} – 24 mA I _{OH} – 24 mA
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA
		4.5 5.5	– –	0.36 0.36	0.44 0.44	V	*V _{IN} = V _{IL} or V _{IH} 24 mA I _{OH} 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	–	±0.1	±1.0	μA	V _I = V _{CC} , GND
ΔI _{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	–	1.5	mA	V _I = V _{CC} – 2.1 V
I _{OLD}	†Minimum Dynamic Output Current	5.5	–	–	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}		5.5	–	–	–75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	–	8.0	80	μA	V _{IN} = V _{CC} or GND

*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

AC CHARACTERISTICS

Symbol	Parameter	V _{CC} * (V)	74ACT			74ACT		Unit	Fig. No.
			T _A = +25°C C _L = 50 pF			T _A = −40°C to +85°C C _L = 50 pF			
			Min	Typ	Max	Min	Max		
f _{max}	Maximum Clock Frequency	5.0	175	—	—	145	—	MHz	3–3
t _{PLH}	Propagation Delay CP to Q _N	5.0	2.0	—	10.0	1.5	11.0	ns	3–6
t _{PHL}	Propagation Delay CP to Q _N	5.0	2.0	—	11.0	1.5	12.0	ns	3–6
t _{PHL}	Propagation Delay MR to Q _N or Q _N	5.0	2.0	—	9.5	1.5	10.5	ns	3–6

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

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AC OPERATING REQUIREMENTS

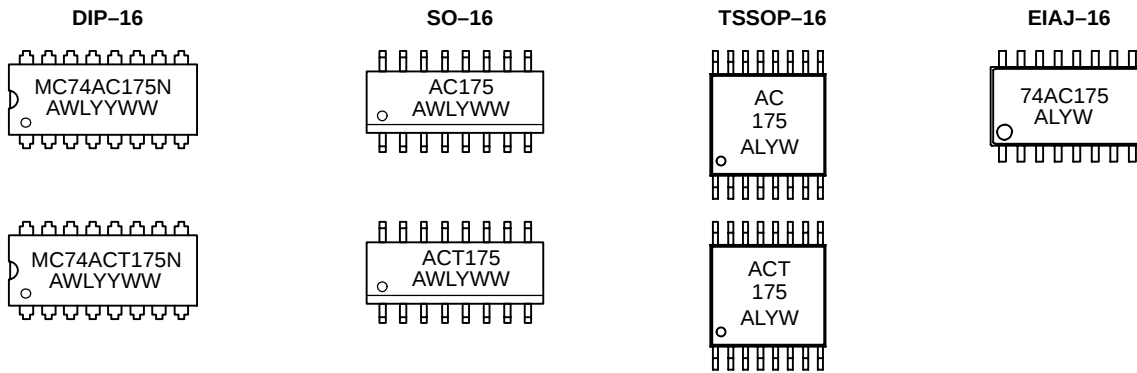
Symbol	Parameter	V _{CC} * (V)	74ACT		74ACT	Unit	Fig. No.
			T _A = +25°C C _L = 50 pF		T _A = −40°C to +85°C C _L = 50 pF		
			Typ	Guaranteed Minimum			
t _S (H) (L)	Set-up Time, HIGH or LOW D _n to CP	5.0	–	2.0 2.5	2.0 2.5	ns	3–9
t _h	Hold Time, HIGH or LOW D _n to CP	5.0	–	1.0	1.0	ns	3–9
t _w	MR Pulse Width, LOW	5.0	–	3.0	4.0	ns	3–6
t _w	CP Pulse Width, HIGH or LOW	5.0	–	3.0	3.5	ns	3–6
t _{rec}	Recovery Time MR to CP	5.0	–	0	0	ns	3–6

*Voltage Range 5.0 V is 5.0 V ±0.5 V.

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = 5.0 V
C _{PD}	Power Dissipation Capacitance	45.0	pF	V _{CC} = 5.0 V

MARKING DIAGRAMS

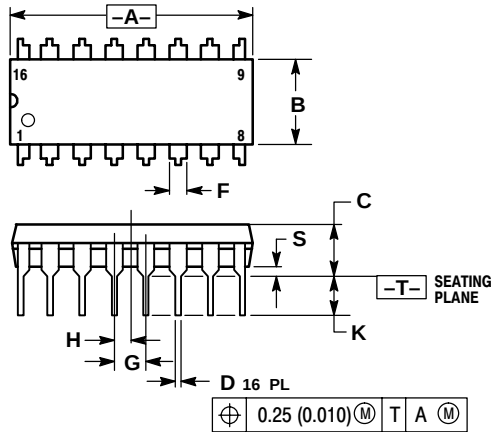


A = Assembly Location
 WL, L = Wafer Lot
 YY, Y = Year
 WW, W = Work Week

MC74AC175, MC74ACT175

PACKAGE DIMENSIONS

PDIP-16 N SUFFIX 16 PIN PLASTIC DIP PACKAGE CASE 648-08 ISSUE R

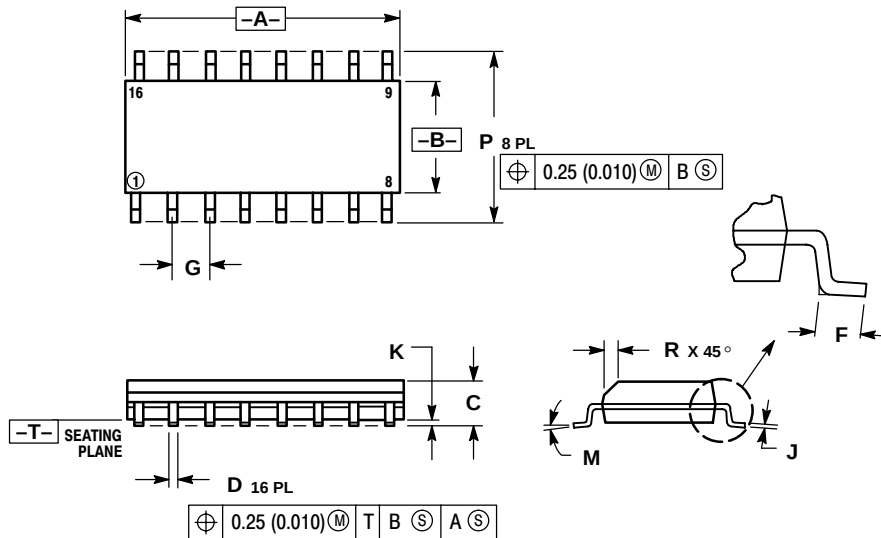


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

SO-16 D SUFFIX 16 PIN PLASTIC SOIC PACKAGE CASE 751B-05 ISSUE J



NOTES:

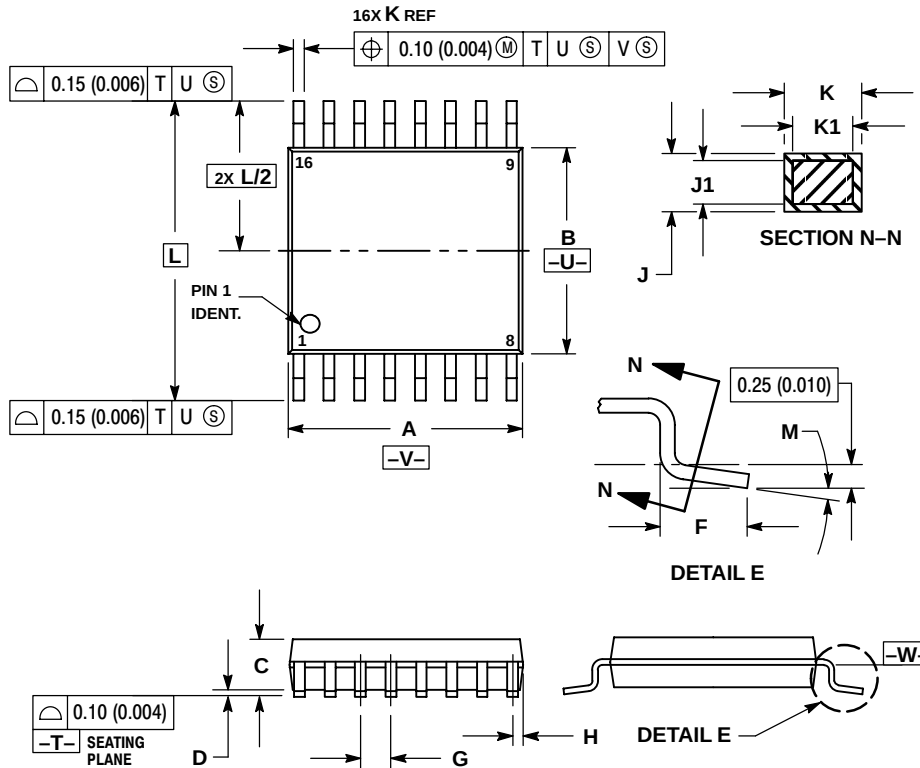
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

MC74AC175, MC74ACT175

PACKAGE DIMENSIONS

TSSOP-16
DT SUFFIX
 16 PIN PLASTIC TSSOP PACKAGE
 CASE948F-01
 ISSUE O

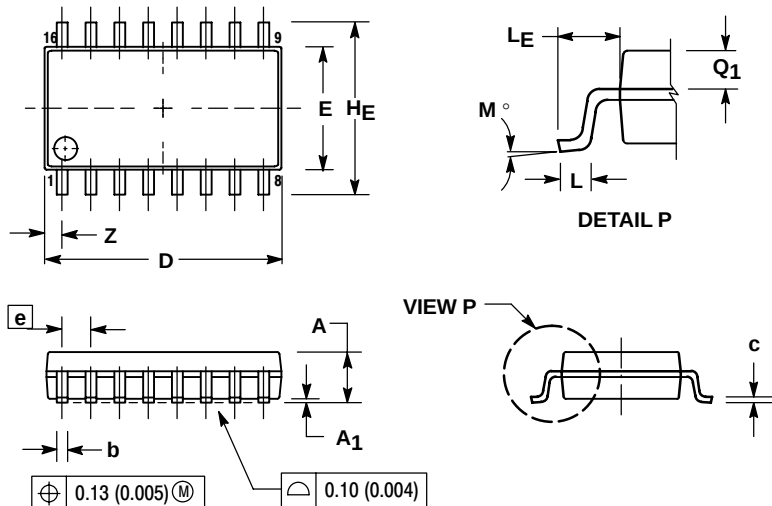


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH. PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.18	0.28	0.007	0.011
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

EIAJ-16
M SUFFIX
 16 PIN PLASTIC EIAJ PACKAGE
 CASE966-01
 ISSUE O



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H _E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L _E	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q ₁	0.70	0.90	0.028	0.035
Z	---	0.78	---	0.031

Notes

Notes

Notes

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